

LINEAR TECHNOLOGY MATERIALS DECLARATION

1tc6752hms8-2#pbf

(Engineering Calculation)

MSOP

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TOTAL MASS (g) : 0.025742

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000851	1000000	33058.78125		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	405290.53125		
		Iron (Fe)	7439-89-6	0.000257	24000	9983.67480469		
		Phosphorus (P)	7723-14-0	0.000003	300	116.54094696		
		Zinc (Zn)	7440-66-6	0.000007	700	271.928863525		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.010700	1000000	415662.71875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	27582.3261719		
		External Plating Total:				0.000710	1000000	27582.3261719
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3340.84033203		
Internal Plating Total:				0.000086	1000000	3340.84033203		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000409	750000	15888.4150391		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000136	250000	5283.18945312		
Die Attach Total:				0.000545	1000000	21171.6054688		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	64447.140625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	411428.40625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	17364.6015625		
		Carbon Black (C)	1333-86-4	0.000064	5000	2486.20678711		
		Encapsulation Total:				0.012761	1000000	495726.3125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000089	1000000	3457.38134766		
					TOTAL MASS (g) :	0.025742		